AgPd Termination Conductive Glue Mounting Chip Multilayer Ceramic Capacitors for Automotive GCG155L81H221KA02_ (0402, X8L:EIA, 220pF, DC50V)

_: packaging code Reference Sheet

1.Scope

This product specification is applied to Chip Multilayer Ceramic Capacitors limited to Conductive Glue Mounting used for Automotive Electronic equipment.

2.MURATA Part NO. System

(Ex.) GCG	15	5	L8	1H	221	K	A02	D
	(1)L/W Dimensions	(2)T Dimensions	(3)Temperature	(4)Rated	(5)Nominal	(6)Capacitance	(7)Murata's Control	(8)Packaging Code

3. Type & Dimensions



(Unit:mm)

1

(1)-1 L	(1)-2 W	(2) T	е	g
1.0±0.1	0.5±0.05	0.5±0.05	0.15 to 0.35	0.3 min.

4.Rated value

` '	(3) Temperature Characteristics (Public STD Code):X8L(EIA)			(5) Nominal	(6) Capacitance	Specifications and Test Methods	
Temp. coef or Cap. Cha		Temp. Range (Ref.Temp.)	Rated Voltage	Capacitance	Tolerance	(Operating Temp. Range)	
-40 to 15 %	6	-55 to 150 °C (25 °C)	DC 50 V	220 pF	±10 %	-55 to 150 °C	

5.Package

J 45			
mark	(8) Packaging	Packaging Unit	
D	φ180mm Reel	1 TOOOD DCS /REEL	
	PAPER W8P2	'	
W	φ180mm Reel PAPER W8P1	20000 pcs./Reel	
	∮330mm Reel	50000 /DI	
J	PAPER W8P2	50000 pcs./Reel	

Product specifications in this catalog are as of Apr.6,2018,and are subject to change or obsolescence without notice. Please consult the approval sheet before ordering.

Please read rating and !Cautions first.

■AEC-Q200 Murata Standard Specification and Test Methods

			Specification.								
No	AEC-Q200	Test Item	Temperature Compensating Type	High Dielectric Type			AE	C-Q200	Test Method		
1	Pre-and Post-S Electrical Test				-						
2	High Temperat	ture	The measured and observed charact	eristics should satisfy the	Fix	the capa	acitor to the test s	ubstrate	in the same man	ner and	
	Exposure (Sto	rage)	specifications in the following table.		under the same conditions as No.16.						
		Appearance	No marking defects		Set the capacitor for 1000+/-12hours at 150+/-3°C. Set for 24+/-2hours at room temperature, then measure.						
		Capacitance	Within +/-2.5% or +/-0.25pF	Within +/-12.5%	7			•	·		
		Change	(Whichever is larger)			nitial me	asurement for hig	h dielec	tric constant type		
		Q or D.F.	30pF min. : Q≧1000	R7/L8: 0.05 max.	Pei	form a h	eat treatment at	150+0/-1	0 °C for 1hour an	d then sit	
			30pF max.: Q ≧400+20C	R9 : 0.075 max.	for	24+/-2hd	ours at room temp	erature.	Perform the initia	al measur	ement.
			C: Nominal Capacitance(pF)								
		I.R.	More than $10000 \text{M}\Omega$ or $500 \Omega \cdot \text{F}$ (W	hichever is smaller)							
		25°C	R9 : More than 3000MΩ or 150 Ω • F	(Whichever is smaller)							
3	Temperature C	Cycling	The measured and observed charact	eristics should satisfy the	Fix	the capa	acitor to the test s	ubstrate	in the same man	ner and	
			specifications in the following table.		unc	er the sa	ame conditions as	No.16.	Perform the 1000) cycles	
		Appearance	No marking defects			-			listed in the follow ture, then measur	•	
		Capacitance	Within +/-2.5% or +/-0.25pF	Within +/-10.0%	┪.						
l		Change	(Whichever is larger)			Step	1	2	3	4	
		Q or D.F.	30pF min. : Q≧1000	R7/L8 W.V.: 25Vmin.: 0.03 max.	4	Temp. (°C)	Min. Operating Temp.+0/-3	Room Temp.	Max. Operating Temp.+3/-0	Room Temp.	
			30pF max.: Q ≧400+20C	W.V.: 16V : 0.05 max		Time					
			C: Nominal Capacitance (pF)	R9 : 0.075 max.		(min)	15+/-3	1	15+/-3	1	
		I.R.	More than $10000M\Omega$ or $500\Omega \cdot F$		┨	nitial me	asurement for hic	nh dielec	tric constant type		
		25°C	(Whichever is smaller)						0 °C for 1hour an	d then sit	
		23 0	(whichever is smaller)						Perform the initia		ement.
4	Destructive	_	No defects or abnormalities		Pei	EIA-469	9.				
5	Physical Analy		The managered and shoomed shorost	ariation about a pation tha							
э	Moisture Resistance		The measured and observed characteristics should satisfy the specifications in the following table.						in the same man	ner and	
			specifications in the following table.				ame conditions as 4-hour heat (25°C) and humidity (80)%RH to	98%RH)
					Apply the 24-hour heat (25°C to 65°C) and humidity (80%RH to 98%RH) treatment shown below, 10 consecutive times.						00 701 11 17
		Appearance	No marking defects		Set for 24+/-2hours at room temperature, then measure.						
		пррешинос	The manning derects			perature		Humidity	Humidit		
						°C)	Humidity	80~98%	Humidity 80~989	6 Humidity	,
		Capacitance	Within +/-3.0% or +/-0.30pF	Within +/-12.5%		70 65	90~98%	 †	90~98%	90~98%	
		Change	(Whichever is larger)			60		\mathbb{N}			H
						55 50			1/1111		\Box
		Q or D.F.	30pF min. : Q≧350	R7/L8: 0.05 max.		45 40					
			10pF and over, 30pF and below:	R9 : 0.075 max.		35					Ш
			Q≧275+5C/2			25 20	+10	++Y		+++	+++
			10pF max.: Q ≧200+10C			15	1 2	℃			++
			C: Nominal Capacitance(pF)			5 Init	ial measuremt				H
						0					
		I.R.	More than 10000MΩ or 500Ω · F (W			-10 L_L		One cy	cle 24hours		
		25°C	R9 : More than 3000MΩ or 150 Ω • F	(Whichever is smaller)		0	1 2 3 4 5 6 7	8 9 10 11	12 13 14 15 16 17 18 Hours	19 20 21 22	23 24
						nitial me	asurement for hig	h dielec	tric constant type		
					Pei	form a h	eat treatment at	150+0/-1	0 °C for 1hour an	d then sit	
					for	24+/-2hd	ours at room temp	erature.	Perform the initia	al measur	ement.
6	Biased Humidi	ty	The measured and observed charact	eristics should satisfy the	Fix	the capa	acitor to the test s	ubstrate	in the same man	ner and	
		-	specifications in the following table.		_		ame conditions as				
		Appearance	No marking defects			-	=		0Vdc (add 6.8kΩ umidity for 1000+		s.
		Canacitanca	Within +/-3.0% or +/-0.30pF	Within +/-12.5%	_				oom temperature,		
		Capacitance Change	(Whichever is larger)	vviuiii T/-12.070			discharge curren				
		Q or D.F.	30pF and over: Q≧200	R7/L8 : 0.05 max.	┤```						
		S. D.I.	30pF and below: Q≧100+10C/3	R9 : 0.075 max.		nitial me	asurement for hid	n dielec	tric constant type		
l			C: Nominal Capacitance(pF)						0 °C for 1hour an	d then sit	
		I.R.	More than $1000M\Omega$ or $50\Omega \cdot F$		_				Perform the initia		
		25°C									
			(Whichever is smaller)								

			Spec	ification.					
No		Test Item	Temperature Compensating Type	High Dielectric Type			AEC-Q200 T	est Method	
7	Operational Lif	е	The measured and observed char-	•			tor to the test substrate in	the same manner and	
		Appearance	specifications in the following table No marking defects		App			00+/-12 hours at maximum opera	ating
		Capacitance	Within +/-3.0% or +/-0.30pF	Within +/-12.5%	-		hours at room temperatur	re then measure	
		Change	(Whichever is larger)	7, 12.676			scharge current is less that		
		Q or D.F.	30pF min. : Q≧350	R7/L8 : 0.05 max.		Ü	· ·		
			10pF and over, 30pF and below:	R9 : 0.075 max.	• In	tial measu	rement for high dielectric	constant type.	
			Q≧275+5C/2		App	ly the test	voltage at the maximum	operating temperature +/-3°C	
			10pF max.: Q ≧200+10C		for '	I hour and	then let sit for 24+/-2hou	rs at room temperature,	
			C: Nominal Capacitance(pF)		ther	measure	•		
		I.R.	More than 1,000M Ω or 50 Ω • F						
_	F. et a 1 \ / i	25°C	(Whichever is smaller)		\ /:	1 !			
8	External Visua	!	No defects or abnormalities		VISU	ıal inspect	ion		
9	Physical Dimer	nsion	Within the specified dimensions		Usir	ng Measur	ing instrument of dimensi	on.	
10	Resistance to Solvents	Appearance	No marking defects				202 Method 215	and already	
	Convents				Sol		part (by volume) of isopro	• •	
		Capacitance	Within the specified initial value.				parts (by volume) of mine	rai spirits	
					Sol	vent 2 : Te	erpene defluxer		
		Q or D.F.	Within the specified initial value.		Sol	vent 3 : 42	2 parts (by volume) of wat	er	
						1part (by v	olume) of propylene glyc	ol monomethyl ether	
		I.R.	More than $10000M\Omega$ or $500\Omega \cdot F$		1 part (by	volume) of monoethanola	mine		
		25°C	(Whichever is smaller)						
11	Mechanical Shock	Appearance	No marking defects				tor to the test substrate in ns as No.16.	the same manner and	
		Capacitance	Within the specified initial value.		Three shocks in each direction should be applied along 3 mutually				
			·		per	endicular	axes of the test specime	n (18 shocks).	
		Q or D.F.	Within the specified initial value. More than 10000M Ω or 500 Ω • F			specified	test pulse should be Half-	-sine and should have a	
						ation :0.5m	s, peak value:1500g and	velocity change: 4.7m/s.	
		I.R.							
		25°C	(Whichever is smaller)		Fix the capacitor to the test substrate in the same manner and same conditions as No.16.				
12	Vibration	Appearance	No marking defects						
		Capacitance	Within the specified initial value.		The capacitor should be subjected to a simple harmonic motion having				
		0 0 5	NACIAL: Also as a side of initial control		4		•	cy being varied uniformly	
		Q or D.F.	Within the specified initial value.				pproximate limits of 10Hz		
		I.R.	M th 40000MO 500 O F		1		range, from 10Hz to 200 ersed in approximately 20		
		25°C	More than $10000M\Omega$ or $500\Omega \cdot F$ (Whichever is smaller)				nould be applied for 12 cy		
			(Whichever is smaller)				directions (total of 36 time	•	
13	Thermal Shock	(The measured and observed char-	acteristics should satisfy the	Fix	the capaci	tor to the test substrate in	the same manner and	
		t	specifications in the following table	l.	und	er the sam	ne conditions as No.16.		
		Appearance	No marking defects				-	e two heat treatments listed	
		Canadia	Within 1/250/ 1/205 5	Mishin - / 10 00/	-		g table(Maximum transfer	,	
		Capacitance Change	Within +/-2.5% or +/-0.25pF (Whichever is larger)	Within +/-10.0%	set	101 24+/-2	hours at room temperatur		
		Change	(vvincilevel is larger)			Step	1	2	
		Q or D.F.	30pF min. : Q≧1000	R7/L8 : W.V.: 25V min.: 0.025 max.*	1	Temp.(°C)	Min. Operating Temp.+0/-3	Max. Operating Temp.+3/-0	
			30pF max.: Q ≧400+20C	*GCG21BL81H104K: 0.03 max.		Time (min)	15+/-3	15+/-3	
			C: Nominal Capacitance(pF)	W.V.: 16V : 0.035 max.		(IIIIII)	1		
				R9: 0.075 max.					
							urement for high dielectri		
		I.R.	More than $10000M\Omega$ or $500\Omega \cdot F$					°C for 1hour and then sit	
		25℃	(Whichever is smaller)		tor 2	24+/-2houi	s at room temperature. P	erform the initial measurement.	

			Specifi	ication.					
No	AEC-Q2	200 Test Item	Temperature Compensating Type	High Dielectric Type	AEC-Q200 Test Method				
14	ESD	Appearance	No marking defects		Per AEC-Q200-002				
		Capacitance	Within the specified initial value.						
		Q or D.F.	Within the specified initial value.						
		I.R.	More than 10000M Ω or 500 Ω • F						
		25°C	(Whichever is smaller)						
15	Electrical Chatacteri-	Appearance	No defects or abnormalities		Visual inspection.				
	zation	Capacitance	Shown in Rated value.		The capacitance/Q/D.F. should be measured at 25°C at the frequency and voltage shown in the table.				
		Q or D.F.	30pF min. : Q≧1000 30pF max.: Q≧400+20C C: Nominal Capacitance(pF)	R7/L8: W.V.: 25Vmin.: 0.025 max. W.V.: 16V : 0.035 max. R9: 0.075 max.	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$				
		I.R. 25°C	More than 100000MΩ or 1000Ω \cdot F (Whichever is smaller)	More than $10000M\Omega$ or $500\Omega \cdot F$ (Whichever is smaller)	The insulation resistance should be measured with a DC voltage not exceeding the rated voltage at 25°C and 125°C(for Δ C/R7)/ 150°C				
					(for 5G/L8/R9) within 2 minutes of charging.				
		I.R. 125°C	More than 10000MΩ or 100Ω · F (Whichever is smaller)	More than 1000MΩ or 10Ω • F (Whichever is smaller)	The charge/discharge current is less than 50mA.				
		I.R. 150°C	More than 10000MΩ or 100Ω • F (Whichever is smaller)	More than 1000MΩ or 1Ω • F (Whichever is smaller)					
		Dielectric Strength	No failure		No failure should be observed when 250% of the rated voltage is applied between the terminations for 1 second to 5 seconds. The charge/discharge current is less than 50mA.				
16	Terminal Strength	Appearance	No marking defects		Mount the capacitor on the test substrate in Fig.1 using a conductive glue (HEREAUS"PC3000").				
		Capacitance	Within the specified initial value.		The conductive glue is hardened at 140°C for 30 minites. Then apply *shear tension in parallel with the test substrate for 60 seconds.				
		Q or D.F.	Within the specified initial value.		*Show in the table 1				
		I.R. 25°C	More than $10000M\Omega$ or $500\Omega \cdot F$ (Whichever is smaller)		Series				

■AEC-Q200 Murata Standard Specification and Test Methods

		Specil	fication.	
No	AEC-Q200 Test Item	Temperature Compensating Type	High Dielectric Type	AEC-Q200 Test Method
17	Beam Load Test	Chip thickness = < Chip L dimension : 3.2mm mim. > Chip thickness <	• 0.5mm rank : 20N = 0.5mm rank : 8N	Place the capacitor in the beam load fixture as Fig 2. Apply a force. < Chip Length: 2.5mm max. > Iron Board < Chip Length: 3.2mm min. > Liphical Fig.2 Speed supplied the Stress Load: 0.5mm/s.
18	Capacitance Temperature Characteristics	But, the Capacitance Change under Reference Temp. is	R7: Within +/-15% (-55°C to +125°C) L8: Within +/-15% (-55°C to +125°C) Within +15/-40% (+125°C to +150°C) R9: Within +/-15% (-55°C to +150°C)	The capacitance change should be measured after 5 minutes at each specified temp. stage. Capacitance value as a reference is the value in step 3. (1)Temperature Compensating Type The capacitance drift is calculated by dividing the differences between the maximum and minimum measured values in the step 1,3 and 5 by the cap. value in step 3. Step

Table A Capacitance Change between at Reference Temp. and at each Temp. (%)

Char.	-5	55	-3	30	-10		
Char.	Max.	Min.	Max.	Min.	Max.	Min.	
5C/5G 0.58		-0.24	0.40	-0.17	0.25	-0.11	

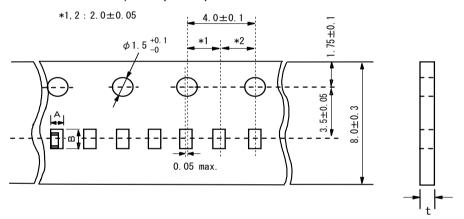
- 1.Tape Carrier Packaging(Packaging Code:D/E/W/F/L/J/K)
- 1.1 Minimum Quantity(pcs./reel)

			φ180mm reel		φ330mm reel		
Ty	/pe	Paper	^r Tape	Plastic Tape	Paper Tape	Plastic Tape	
		Code:D/E	Code:W	Code:L	Code:J/ F	Code:K	
GCG15	F	10000	20000		50000		
GCG15	5	(W8P2)	(W8P1)		(W8P2)		
GCG18	8	4000			10000		
	6	4000			10000		
GCG21	9	4000			10000		
	В			3000		10000	
GCG31	М			3000		10000	
GCG31	С			2000		6000	
GCG32	D			1000		4000	
GCG32	E			1000		4000	

1.2 Dimensions of Tape

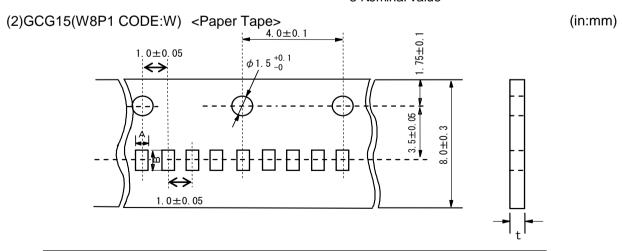
(1)GCG15(W8P2 CODE:D/E/J/F) <Paper Tape>

(in:mm)



	Туре		Dimensions(Chip)			A *3	B *3	+
			L	W	Т	A 3	ВЗ	
	GCG15	5	1.0±0.1	0.5±0.05	0.5±0.05	0.65	1.15	0.8 max.

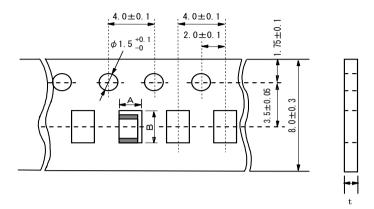
*3 Nominal value



Type	Type		nensions(Cl	nip)	A *3	B *3	+	
Туре		L	W	Т	Α 3	ט	L	
GCG15	5	1.0±0.1	0.5±0.05	0.5±0.05	0.65	1.15	0.8 max.	

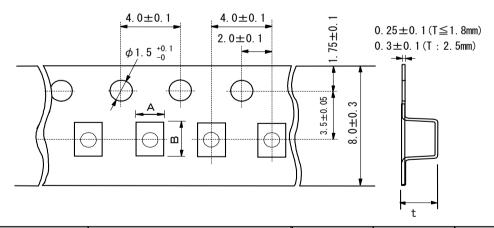
(3)GCG18/21 <Paper Tape>

(in:mm)



Туре		Dimentions(Chip)			Δ.	Б	
		L	W	Т	А	В	t
GCG18	8	1.6±0.2	0.8±0.1	0.8±0.1	1.05±0.10	1.85±0.10	
GCG21	6	2.0±0.3	1.25±0.2	0.6±0.1	1.55±0.15	2.30±0.15	1.1 max.
	9			0.85±0.1			

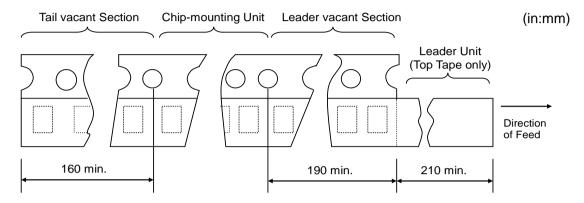
(4)GCG21/31/32 <Plastic Tape>



Туре		Dimentions(Chip)				1	
		L	W	Т	Α	В	τ
GCG21	В	2.0±0.3	1.25±0.2	1.25±0.2	1.45±0.20	2.25±0.20	2.0 max.
GCG31	М	3.2±0.3	1.6±0.3	1.15±0.2	1.90±0.20	3.50±0.20	1.7 max.
	С			1.6±0.3			2.5 max.
		3.2±0.4	1.6±0.4	1.6±0.4	2.10±0.20	3.60±0.20	
GCG32	D	3.2±0.4	2.5±0.3	2.0±0.3	2.80±0.20	3.50±0.20	3.0 max.
	Е			2.5±0.3			3.7 max.

Fig.1 Package Chips (in:mm) Chip Fig.2 Dimensions of Reel 2.0±0.5 φ21±0.8 φ180+0/-3.0 φ330±2.0 φ50 min. W W_1 Taping Diagram GCG32 max. 16.5 max. 10±1.5 Top Tape: Thickness 0.06 A Feeding Hole : As specified in 1.2. Hole for Chip: As specified in 1.2. Bottom Tape : Thickness 0.05 (Only a bottom tape existence) Base Tape: As specified in 1.2.

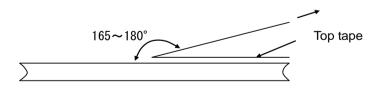
- 1.3 Tapes for capacitors are wound clockwise shown in Fig.3. (The sprocket holes are to the right as the tape is pulled toward the user.)
- 1.4 Part of the leader and part of the vacant section are attached as follows.



- 1.5 Accumulate pitch: 10 of sprocket holes pitch = 40±0.3mm
- 1.6 Chip in the tape is enclosed by top tape and bottom tape as shown in Fig.1.
- 1.7 The top tape and base tape are not attached at the end of the tape for a minimum of 5 pitches.
- 1.8 There are no jointing for top tape and bottom tape.
- 1.9 There are no fuzz in the cavity.
- 1.10 Break down force of top tape : 5N min.

 Break down force of bottom tape : 5N min. (Only a bottom tape existence)
- 1.11 Reel is made by resin and appeaser and dimension is shown in Fig 2.

 There are possibly to change the material and dimension due to some impairment.
- 1.12 Peeling off force: 0.1N to 0.6N in the direction as shown below.



1.13 Label that show the customer parts number, our parts number, our company name, inspection number and quantity, will be put in outside of reel.

■Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment (2) Aerospace equipment (3) Undersea equipment (4) Power plant control equipment
- ⑤Medical equipment ⑥Transportation equipment(vehicles,trains,ships,etc.) ⑦Traffic signal equipment
- (MApplication of similar complexity and/or reliability requirements to the applications listed in the above.

■ Storage and Operation condition

1. If store the chip multilayer ceramic capacitors in an atmosphere consisting of high temperature or humidity, sulfur or chlorine gases, contaminants attach to the surface of external electrode, and bondability with conductive glue may deteriorate. Do not store the capacitors in an atmosphere consisting of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammoria gas, etc.). Storage environment must be at room temperature of +5°C to +40°C and a relative humidity of 20% to 70%, and use the product within six months after receipt.

In case of packaging, do not open the last wrappend, polyethylene bag, till just before using. After unpacking, immediately reseal, or store in a desiccator containing a desiccant.

- 2. Due to moisture condensation caused by rapid humidity changes, or the photochemical change caused by direct sunlight on the terminal electrodes and/or the resin/epoxy coatings, the bondability with conductive glue and electrical performance may deteriorate. Do not store capacitors under direct sunlight or in high humidity conditions.
- 3. This product is chip monolithic ceramic capacitor limited to conductive glue mounting. Do not apply mounting method other than conductive glue. Flow or reflow soldering can result in a lack of adhesive strength on the outer electrode by poor wettability, which may result in chips breaking loose from the PCB.

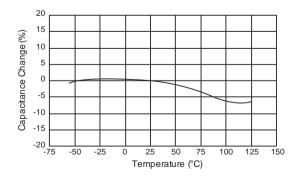
■ Rating

1.Temperature Dependent Characteristics

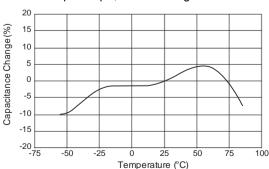
- 1. The electrical characteristics of the capacitor can change with temperature.
- 1-1. For capacitors having larger temperature dependency, the capacitance may change with temperature changes. The following actions are recommended in order to ensure suitable capacitance values.
 - (1) Select a suitable capacitance for the operating temperature range.
 - (2) The capacitance may change within the rated temperature.

 When you use a high dielectric constant type capacitor in a circuit that needs a tight (narrow) capacitance tolerance (e.g., a time-constant circuit), please carefully consider the temperature characteristics, and carefully confirm the various characteristics in actual use conditions and the actual system.

[Example of Temperature Caracteristics X7R(R7)] Sample: 0.1µF, Rated Voltage 50VDC



[Example of Temperature Characteristics X5R(R6)] Sample: 22µF, Rated Voltage 4VDC



2.Measurement of Capacitance

- 1. Measure capacitance with the voltage and frequency specified in the product specifications.
- 1-1. The output voltage of the measuring equipment may decrease occasionally when capacitance is high. Please confirm whether a prescribed measured voltage is impressed to the capacitor.
- 1-2. The capacitance values of high dielectric constant type capacitors change depending on the AC voltage applied. Please consider the AC voltage characteristics when selecting a capacitor to be used in a AC circuit.

3.Applied Voltage

- 1. Do not apply a voltage to the capacitor that exceeds the rated voltage as called out in the specifications.
- 1-1. Applied voltage between the terminals of a capacitor shall be less than or equal to the rated voltage.
 - (1) When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated DC voltage. When AC voltage or pulse voltage is applied, the peak-to-peak voltage shall not exceed the rated DC voltage.
 - (2) Abnormal voltages (surge voltage, static electricity, pulse voltage, etc.) shall not exceed the rated DC voltage.



(E: Maximum possible applied voltage.)

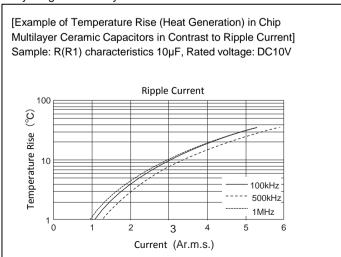
1-2. Influence of over voltage

Over voltage that is applied to the capacitor may result in an electrical short circuit caused by the breakdown of the internal dielectric layers.

The time duration until breakdown depends on the applied voltage and the ambient temperature.

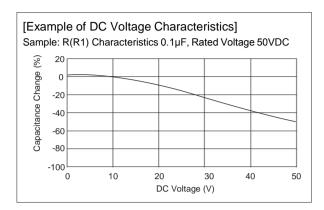
4. Type of Applied Voltage and Self-heating Temperature

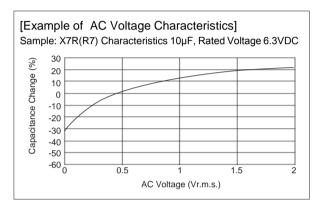
- 1. Confirm the operating conditions to make sure that no large current is flowing into the capacitor due to the continuous application of an AC voltage or pulse voltage.
 - When a DC rated voltage product is used in an AC voltage circuit or a pulse voltage circuit, the AC current or pulse current will flow into the capacitor; therefore check the self-heating condition.
 - Please confirm the surface temperature of the capacitor so that the temperature remains within the upper limits of the operating temperature, including the rise in temperature due to self-heating. When the capacitor is used with a high-frequency voltage or pulse voltage, heat may be generated by dielectric loss.
- <Applicable to Rated Voltage of less than 100VDC>
 The load should be contained so that the self-heating of the capacitor body remains below 20°C, when measuring at an ambient temperature of 25°C.



5. DC Voltage and AC Voltage Characteristic

- The capacitance value of a high dielectric constant type capacitor changes depending on the DC voltage applied. Please consider the DC voltage characteristics when a capacitor is selected for use in a DC circuit.
- 1-1. The capacitance of ceramic capacitors may change sharply depending on the applied voltage. (See figure) Please confirm the following in order to secure the capacitance.
- (1) Determine whether the capacitance change caused by the applied voltage is within the allowed range.
- (2) In the DC voltage characteristics, the rate of capacitance change becomes larger as voltage increases, even if the applied voltage is below the rated voltage. When a high dielectric constant type capacitor is used in a circuit that requires a tight (narrow) capacitance tolerance (e.g., a time constant circuit), please carefully consider the voltage characteristics, and confirm the various characteristics in the actual operating conditions of the system.
- The capacitance values of high dielectric constant type capacitors changes depending on the AC voltage applied.
 Please consider the AC voltage characteristics when selecting a capacitor to be used in a AC circuit.





6. Capacitance Aging

1. The high dielectric constant type capacitors have an Aging characteristic in which the capacitance value decreases with the passage of time. When you use a high dielectric constant type capacitors in a circuit that needs a tight (narrow) capacitance tolerance (e.g., a time-constant circuit), please carefully consider the characteristics of these capacitors, such as their aging, voltage, and temperature characteristics. In addition, check capacitors using your actual appliances at the intended environment and operating conditions.

[Example of Change Over Time (Aging characteristics)]

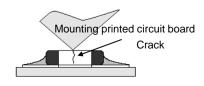


7.Vibration and Shock

- 1. Please confirm the kind of vibration and/or shock, its condition, and any generation of resonance.

 Please mount the capacitor so as not to generate resonance, and do not allow any impact on the terminals.
- Mechanical shock due to being dropped may cause damage or a crack in the dielectric material of the capacitor.Do not use a dropped capacitor because the quality and reliability may be deteriorated.
- 3. When printed circuit boards are piled up or handled, the corner of another printed circuit board should not be allowed to hit the capacitor in order to avoid a crack or other damage to the capacitor.





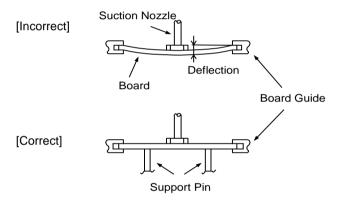
■ Mounting

1. Selection of Conductive Adhesive, Mounting Process, and Bonding Strength

1.The acuired bonding strength may change greatly depending on the conductive adhesive to be used. Be sure to confirming the desired performance can be acquired in the assumed monting process with the conductive adhesive to be used.

2. Maintenance of the Mounting (pick and place) Machine

- Make sure that the following excessive forces are not applied to the capacitors.
 Check the mounting in the actual device under actual use conditions ahead of time.
- 1-1. In mounting the capacitors on the printed circuit board, any bending force against them shall be kept to a minimum to prevent them from any damage or cracking. Please take into account the following precautions and recommendations for use in your process.
 - (1) Adjust the lowest position of the pickup nozzle so as not to bend the printed circuit board.



2.Dirt particles and dust accumulated in the suction nozzle and suction mechanism prevent the nozzle from moving smoothly. This creates excessive force on the capacitor during mounting, causing cracked chips. Also, the locating claw, when worn out, imposes uneven forces on the chip when positioning, causing cracked chips. The suction nozzle and the locating claw must be maintained, checked and replaced periodically.

3.Moisture proof

1.To prevent the silver electrode migration, keep parts under low moisture condition with resin coating and the equivalent.

4.Coating

- 1. A crack may be caused in the capacitor due to the stress of the thermal contraction of the resin during curing process. The stress is affected by the amount of resin and curing contraction. Select a resin with low curing contraction. The difference in the thermal expansion coefficient between a coating resin or a molding resin and the capacitor may cause the destruction and deterioration of the capacitor such as a crack or peeling, and lead to the deterioration of insulation resistance or dielectric breakdown.
 - Select a resin for which the thermal expansion coefficient is as close to that of the capacitor as possible. A silicone resin can be used as an under-coating to buffer against the stress.
- Select a resin that is less hygroscopic.
 Using hygroscopic resins under high humidity conditions may cause the deterioration of the insulation resistance of a capacitor. An epoxy resin can be used as a less hygroscopic resin.
- 3. The halogen system substance and organic acid are included in coating material, and a chip corrodes by the kind of Coating material. Do not use strong acid type.

Others

1. Under Operation of Equipment

- 1-1. Do not touch a capacitor directly with bare hands during operation in order to avoid the danger of an electric shock.
- 1-2. Do not allow the terminals of a capacitor to come in contact with any conductive objects (short-circuit). Do not expose a capacitor to a conductive liquid, inducing any acid or alkali solutions.
- 1-3. Confirm the environment in which the equipment will operate is under the specified conditions.
 - Do not use the equipment under the following environments.
 - (1) Being spattered with water or oil.
 - (2) Being exposed to direct sunlight.
 - (3) Being exposed to ozone, ultraviolet rays, or radiation.
 - (4) Being exposed to toxic gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
 - (5) Any vibrations or mechanical shocks exceeding the specified limits.
 - (6) Moisture condensing environments.
- 1-4. Use damp proof countermeasures if using under any conditions that can cause condensation.

2. Others

2-1. In an Emergency

- (1) If the equipment should generate smoke, fire, or smell, immediately turn off or unplug the equipment. If the equipment is not turned off or unplugged, the hazards may be worsened by supplying continuous power.
- (2) In this type of situation, do not allow face and hands to come in contact with the capacitor or burns may be caused by the capacitor's high temperature.

2-2. Disposal of waste

When capacitors are disposed of, they must be burned or buried by an industrial waste vendor with the appropriate licenses.

2-3. Circuit Design

(1) Addition of Fail Safe Function

Capacitors that are cracked by dropping or bending of the board may cause deterioration of the insulation resistance, and result in a short. If the circuit being used may cause an electrical shock, smoke or fire when a capacitor is shorted, be sure to install fail-safe functions, such as a fuse, to prevent secondary accidents.

(2) This series are not safety standard certified products.

2-4. Remarks

Failure to follow the cautions may result, worst case, in a short circuit and smoking when the product is used. The above notices are for standard applications and conditions. Contact us when the products are used in special mounting conditions.

Select optimum conditions for operation as they determine the reliability of the product after assembly.

The data herein are given in typical values, not guaranteed ratings.

Rating

1.Operating Temperature

- 1. The operating temperature limit depends on the capacitor.
- 1-1. Do not apply temperatures exceeding the maximum operating temperature.

 It is necessary to select a capacitor with a suitable rated temperature that will cover the operating temperature range.

 It is also necessary to consider the temperature distribution in equipment and the seasonal temperature variable factor.
- 1-2. Consider the self-heating factor of the capacitor

 The surface temperature of the capacitor shall not exceed the maximum operating temperature including self-heating.

2.Atmosphere Surroundings (gaseous and liquid)

- 1. Restriction on the operating environment of capacitors.
- 1-1. Capacitors, when used in the above, unsuitable, operating environments may deteriorate due to the corrosion of the terminations and the penetration of moisture into the capacitor.
- 1-2. The same phenomenon as the above may occur when the electrodes or terminals of the capacitor are subject to moisture condensation.
- 1-3. The deterioration of characteristics and insulation resistance due to the oxidization or corrosion of terminal electrodes may result in breakdown when the capacitor is exposed to corrosive or volatile gases or solvents for long periods of time.

3.Piezo-electric Phenomenon

 When using high dielectric constant type capacitors in AC or pulse circuits, the capacitor itself vibrates at specific frequencies and noise may be generated.
 Moreover, when the mechanical vibration or shock is added to capacitor, noise may occur.

Others

1.Transportation

- 1. The performance of a capacitor may be affected by the conditions during transportation.
- 1-1. The capacitors shall be protected against excessive temperature, humidity and mechanical force during transportation.
 - (1) Climatic condition
 - · low air temperature : -40°C
 - · change of temperature air/air : -25°C/+25°C
 - · low air pressure : 30 kPa
 - · change of air pressure : 6 kPa/min.
 - (2) Mechanical condition

Transportation shall be done in such a way that the boxes are not deformed and forces are not directly passed on to the inner packaging.

- 1-2. Do not apply excessive vibration, shock, or pressure to the capacitor.
 - (1) When excessive mechanical shock or pressure is applied to a capacitor, chipping or cracking may occur in the ceramic body of the capacitor.
 - (2) When the sharp edge of an air driver, tweezers, a chassis, etc. impacts strongly on the surface of the capacitor, the capacitor may crack and short-circuit.
- 1-3. Do not use a capacitor to which excessive shock was applied by dropping etc. A capacitor dropped accidentally during processing may be damaged.

2. Characteristics Evaluation in the Actual System

- 1. Evaluate the capacitor in the actual system,to confirm that there is no problem with the performance and specification values in a finished product before using.
- 2. Since a voltage dependency and temperature dependency exists in the capacitance of high dielectric type ceramic capacitors, the capacitance may change depending on the operating conditions in the actual system. Therefore, be sure to evaluate the various characteristics, such as the leakage current and noise absorptivity, which will affect the capacitance value of the capacitor.
- 3. In addition,voltages exceeding the predetermined surge may be applied to the capacitor by the inductance in the actual system. Evaluate the surge resistance in the actual system as required.



⚠ NOTE

- 1.Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. Your are requested not to use our product deviating from this product specification.
- 3.We consider it not appropriate to include any terms and conditions with regard to the business transaction in the product specifications, drawings or other technical documents. Therefore, if your technical documents as above include such terms and conditions such as warranty clause, product liability clause, or intellectual property infringement liability clause, they will be deemed to be invalid.